

MUROHARA - 10/665,420
Client/Matter: 008312-0306032

IN THE CLAIMS:

This listing of claims will replace all prior versions, and listings, of claims in the application:

1. (Currently Amended) A method of mounting a combination-type IC card having: (i) a tuning circuit including an antenna and ~~at least one~~ a tuning capacitor for trimming ~~in an antenna card and on a first substrate~~; (ii) an IC module ~~including LSI, which is~~ electrically connected to the tuning circuit and mounted on the ~~antenna card~~ first substrate, and ~~wherein the IC module including an LSI, and~~ a contact portion connected to an external device, ~~the LSI and the contact portion mounted on a second substrate~~; and (iii) a resonance circuit including the tuning circuit and ~~the LSI, wherein the method of mounting a combination-type IC card comprising:~~

a milling step of making a hole in the first substrate in which the IC module is mounted ~~in the antenna card~~;

a trimming step of setting a resonance frequency to one of various resonance frequencies ~~currently with the milling step~~ by selectively cutting a signal line which connects the tuning capacitor for trimming and the antenna; and

an implanting step of mounting the IC module into the hole formed in the first substrate after the trimming step.

2. (Currently Amended) The method according to claim 1, wherein the signal line to be trimmed is exposed in forming a rectangular hole, in which the IC module is mounted, in ~~the antenna card~~ first substrate through the milling step.

3. (Currently Amended) The method according to claim 1, wherein the signal line to be cut is exposed at a side different from a side where both end terminals of the antenna are

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exposed in forming a rectangular hole, in which the IC module is mounted, in the antenna card first substrate through the milling step.

4. (Original) The method according to claim 1, wherein the signal line to be cut is provided at a position where the signal line is exposed after milling through the milling step.

5. (Original) A mounting method of a combination-type IC card according to claim 1, wherein the trimming step carries out trimming by cutting a part of an exposed pattern exposed after milling through the milling step.

6. (Currently Amended) A combination-type card comprising:

an antenna card incorporating an antenna terminal and an LSI having a tuning circuit including an antenna and at least one tuning capacitor, the antenna having antenna terminals and being mounted on a first substrate, and the at least one tuning condenser being connected to the antenna and the antenna terminals via a signal line; and

an IC module; held in the antenna card and including a contact unit and an antenna-connecting terminal electrically connected to the antenna terminal the contact unit being connected to the LSI and to be connected to an external device (i) electrically connected to the tuning circuit; (ii) mounted on the first substrate; and (iii) including an LSI, a contact portion connected to an external device, and antenna-connecting terminals, the LSI, the contact portion and the antenna-connecting terminals mounted on a second substrate,

wherein the antenna card comprises a plurality of tuning capacitors connected by signal lines to the antenna terminal, the antenna and the tuning capacitors constitute a tuning circuit, the tuning circuit and the LSI constitute a resonant, and the antenna-connecting

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terminals of the IC module and the antenna of the antenna card are electrically connected,
thereby configuring a resonant circuit including the tuning circuit and the LSI, and
wherein a resonance frequency of the resonant circuit is adjusted to one of various
resonance frequencies by selectively cutting at least one of the signal lines.

7. (Currently Amended) The combination-type card according to claim 6, wherein at
least one of the signal lines a signal line is selectively cut when a hole is made in the ~~antenna~~
~~card~~ first substrate to hold the IC module.